Amendments to the Claims

Please amend the claims as follows:

1. (Currently Amended) An input device comprising:

an electrostatic-capacitance-type input sensor including a flexible substrate;

a plurality of X electrodes that are formed on the flexible substrate and that are disposed on an insulating layer and a plurality of Y electrodes that are disposed on an insulating layer; and

an extension section that is extended from the flexible substrate,

wherein the X and Y electrodes are connected to a circuit substrate provided in the extension section, and a reverse surface of the flexible substrate on which the X and Y electrodes are not formed is bonded along a rear surface of a curved portion of an insulating support plate. ~~the electrodes are bonded to a rear surface of an insulating support plate that supports the input sensor, and the circuit substrate is bonded to the insulating support plate.~~

2. (Original) An electrostatic-capacitance-type coordinate input device according to Claim 1, wherein a recess to which the input sensor is fitted is formed on the rear surface of said support plate at a position where said input sensor is bonded.

3. (Previously Presented) An electrostatic-capacitance-type coordinate input device according to Claim 1, wherein a pointing section for pointing a position of said input sensor is formed in said support plate.

4. – 7. (Cancelled)

8. (Currently Amended) A device, comprising;

an input device having a coordinate-input sensor formed on a flexible substrate and having an electrode layer for detecting electrostatic capacitance;

a device housing having an insulating portion having obverse and reverse sides, the obverse side being exposed;

wherein the input sensor is disposed on the reverse side of the insulating portion and an input operation is performable at the obverse side, ~~and~~

wherein the coordinate-input sensor has an extension section, the extension section is provided with a circuit substrate to which the electrodes are connected, the input sensor is bonded around a support plate of a curved surface, and the circuit substrate is bonded to a support plate of a planar surface, and

wherein the input device includes a single flexible substrate, and a reverse surface of the flexible substrate on which X and Y electrodes are not formed is bonded along a rear surface of a curved portion of an insulating support plate.

9. (Previously Presented) The device according to claim 8, wherein the input sensor is bonded to an arcuate section formed in the insulating portion.

10. (Previously Presented) The device according to claim 8, wherein the input sensor is bonded to a recessed area formed in the reverse side.

11. (New) An electrostatic-capacitance-type coordinate input device according to Claim 1, wherein the reverse surface of the flexible substrate corresponding to the extension section is bonded to a rear surface of a planar portion of the insulating support plate.

12. (New) The device according to claim 8, wherein the reverse surface of the flexible substrate corresponding to the extension section is bonded to a rear surface of a planar portion of the insulating support plate